



SPECIFICATION FOR LCD MODULE

Customer : _____

Product Model: KD43G18-40NB-A1

Sample code: _____

Designed by	Checked by	Approved by

Final Approval by Customer

LCM Machinery OK

Checked By _____

LCM Display OK

Checked By _____

LCM OK

NG, Problem survey:

Approved By _____

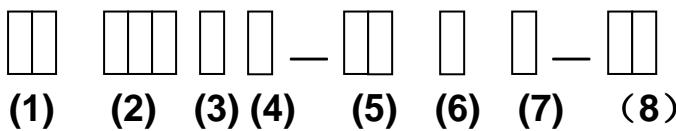
※The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

Revision History

Contents

No.	Item	Page
1.	Numbering System	4/26
2	Scope	5/26
3	Normative Reference	5/26
4	Definitions	5/26
5	Technology Specifications	7/26
6	Circuit block diagram	11/26
7	Initial code	15/26
8	Write/ReadSPI Timing	16/26
9	Reliability Test Condition and Methods	17/26
10	Inspection standard	18/26
11	Handling Precautions	24/26
12	Precaution for use	25/26
13	Dimensional Outline	26/26

1 Numbering System



No	Definition	Specifications
(1)	TFT LCM Productor No.	KD----On□Tat□Industrial□Company
(2)	Display monitor opposite angle line size	Unit :mm or mmm (size <10 inch: takes two integers ; size >=10 inch: takes three integers)
(3)	Productor Types	D ---- Digital photo frame / DVD G ----GPS M ----MP P ----Mobil-Phone o o o
(4)	Productor Development Series No.	By two figures characters expression from 01 to 99
(5)	Interface PIN Number	By two figures characters expression from 01 to 99
(6)	With Touch Panel Or Not	T----With T/P ; N----Without T/P
(7)	LCD Type	A----AUO ; M----CMO ; C----CPT; P----PVI; L----LG; W----Wintek; H----HSD; T----Topply; Y----Hydis; I----Hitach; S----Sharp...
(8)	Productor Development edition No.	By The English litters : A 1~ Z9

2 Scope

3 Normative Reference

GB/T4619-1996 《Liquid Crystal Display Test Method》

GB/T2424 《Basic environmental Testing Procedures for Electric and Electronic Products.》

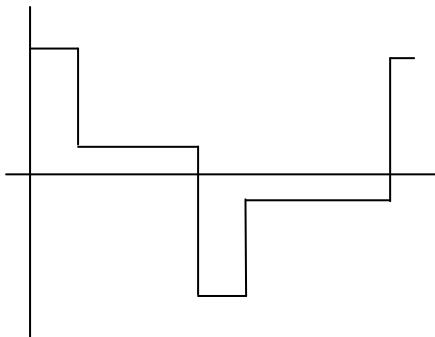
GB/T2423 《Basic Testing Procedures for Electric and Electronic Products》

IEC61747-1 《SIXTH PARTGB2828`2829-87 《National Standard of PRC》

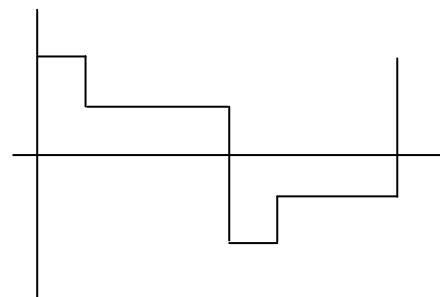
4 Definitions

4.1 Definitions of Vop

The definitions of threshold voltage V_{th1} , V_{th2} the following typical waveforms are applied on liquid crystal by the method of equalized voltage for each duty and bias.



【 selected waveform 】



【 non-selected waveform 】

① V_{th1} : The voltage which the brightness of segment indicates 50% of saturated value on the conditions of selected waveform

($f_f=80\text{Hz}$, $\Phi=10^\circ$ $\theta=270^\circ$ at 25°C)

② V_{th2} : The voltage which the brightness of segment indicates 50% of saturated value on the conditions of non-selected waveform

($f_f=80\text{Hz}$, $\Phi=10^\circ$ $\theta=270^\circ$ at 25°C)

③ V_{op} : $(V_{th1}(50\%)+V_{th2}(50\%))/2$ ($f_f=80\text{Hz}$, $\Phi=10^\circ$ $\theta=270^\circ$ at 25°C)

4.2 Definition of Response Time Tr , Td

① Tr : The time required which the brightness of segment becomes 10% from 100% when waveform is switched to selected one from non-selected one. ($f_f=80\text{Hz}$, $\Phi=10^\circ$ $\theta=270^\circ$ at 25°C)

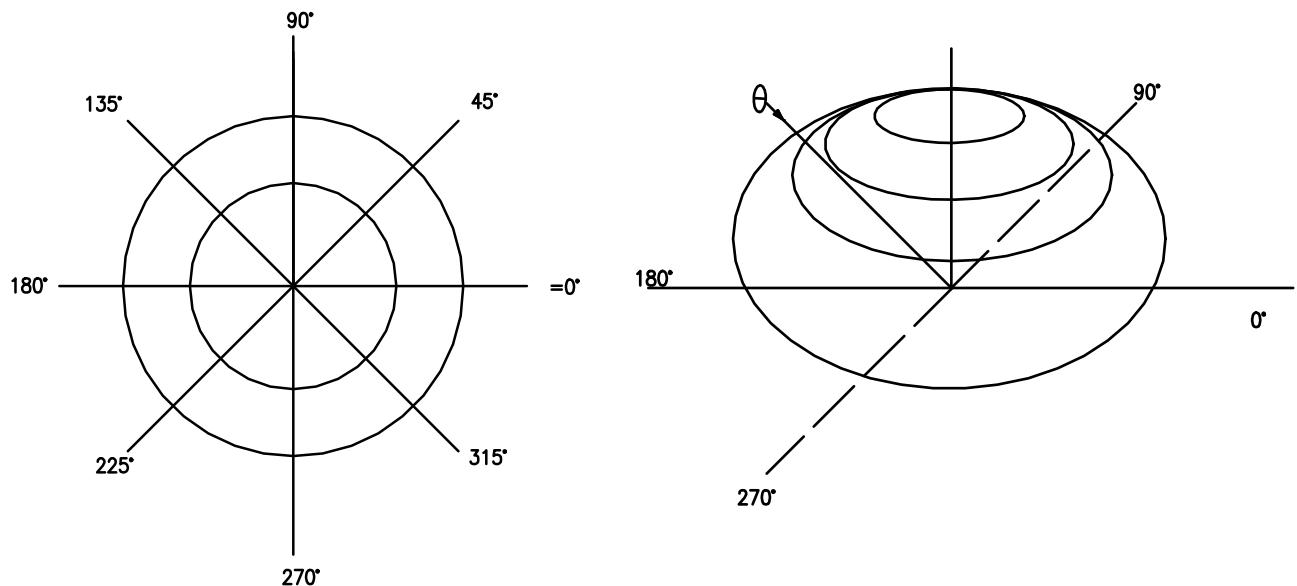
② T_d : The time required which the brightness of segment becomes 90% from 10% when waveform is switched to selected one from selected one. ($f_i=80\text{Hz}$, $\Phi=10^\circ$ $\theta=270^\circ$ at 25°C)

4.3 Definition of Contrast Ratio Cr

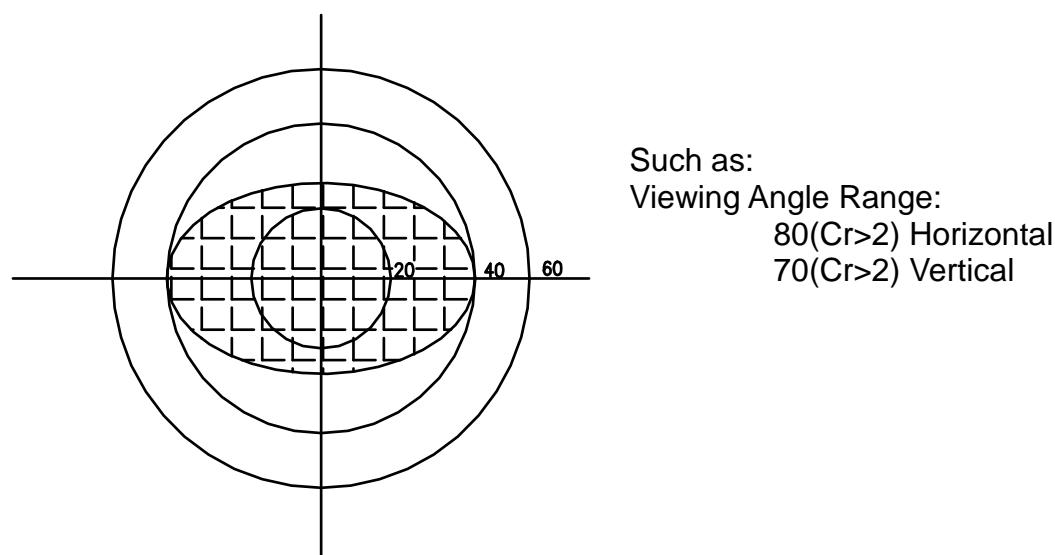
$$Cr = A/B$$

- ① A: Segments brightness in case of non-selected waveform
- ② B: Segments brightness in case of selected waveform

4.4 Definition of Angle and Viewing Range



Angular Graph: Contrast Ratio



5 Technology Specifications

5.1 Feature

This single-display module is suitable for use in Multidedia Player products. The LCD adopts one backlight with High brightness 10-lamps white LED.

- 1) Construction: 4.3" a-Si color TFT-LCD ,White LED backlight.
- 2) LCD:
 - 2.1 Amorphous-TFT 4.3-inch display, transmissive, normally white type.
 - 2.2 480(RGB)×272 dots Matrix.
 - 2.3 Narrow-contact ledge technique.
 - 2.4 LCD Driver IC: HX8257× 1.
- 3) Low cross talk by frame rate modulation.
- 4) 262K Color ,24bit RGB interface.
- 5) Video signal interface: Parallel RGB .

5.2 Mechanical Specifications

Item	Specifications	Unit
Dimensional outline	105.6(W) ×67.3(H)×2.85 (T)	mm
TP outline		mm
TP(V.A)		mm
TP(A.A)		mm
Active area	95.04(W) ×53.86 (H)	mm
Pixel size	198(W) ×198(H)	um
Resolution	480(RGB) × 272	pixel

5.3 Absolute Max. Rating

Item	Symbol	Value			Unit	Remark
		Min	typ	Max		
power supply	VCC	1.8	3.0	3.6	V	
Input high voltage	V _{IH}	0.8VCC	-	VCC	V	
Input low voltage	V _{IL}	0	-	0.2VCC	V	
Operating temperature	T _{OPR}	-20		+70	°C	
Storage temperature	T _{STG}	-30		+80	°C	
Clock frequency	F _{CLK}	-	9	15	MHz	Note1

Note: For parallel RGB interface, maximum clock frequency is 15MHz,

For serial RGB interface, maximum clock frequency is 33MHz,

5.4 Electrical Characteristics (VSS=0V, Ta=-20 to 70°C)

Symbol	Parameter	Test condition	Min.	Spec. Typ.	Max.	Unit
VDDIO	Power supply pin of IO pins	Recommend Operating Voltage Possible Operating Voltage	1.8	-	3.6	V
VCI	Booster Reference Supply Voltage Range	Recommend Operating Voltage Possible Operating Voltage	\geq VDDIO & \geq 3	-	3.6	V
I _{Sleep}	Sleep mode current	-	-	50		μ A
I _{Op}	Operating mode current	VCI=3.3V	-	13	15	mA
VCL	Negative V _{Cl} Output Voltage	No panel loading	- VCI	-	- VCI+0.7	V
VCIX2	Vaux2 primary booster efficiency ⁽¹⁾	No panel loading, ITO for V _{CIx2} , V _{Cl} and V _{CHS} = 10 Ohm	5.2	5.4	5.6	V
VDC	V _{DC} Output Voltage	VDC[3:0]=1011	4.9	5	5.1	V
VGH	Gate driver High Output Voltage Booster efficiency ⁽²⁾	No panel loading; 3x booster	84	89.5	-	%
		No panel loading; 4x booster	80	88.5	-	%
VGL	Gate driver Low Output Voltage	V _{GL} = 2 x VDC	-10	-10	-9	V
COMH	VCOM High Output Voltage ⁽³⁾	-	-3%	COMC+COMPP	3%	V
COML	VCOM Low Output Voltage ⁽³⁾	-	-3%	COMC-COMPP	3%	V
VLCD	V _{LCD} Output Voltage	VRH[5:0]=100100	4.41	4.51	4.61	V
V _{OH1}	Logic High Output Voltage	I _{out} = -100 μ A	0.9*V _{DDIO}	-	V _{DD}	V
V _{VD}	Source Output Voltage Deviation	-	-	\pm 20	\pm 30	mV
V _{OS}	Source Output Voltage Offset	-	-	-	\pm 30	mV
V _{OL1}	Logic Low Output Voltage	I _{out} = 100 μ A	0	-	0.1*V _{DDIO}	V
V _{IH1}	Logic High Input voltage	-	0.8*V _{DDIO}	-	V _{DDIO}	V
V _{IL1}	Logic Low Input voltage	-	0	-	0.2*V _{DDIO}	V
I _{OH}	Logic High Output Current Source	V _{out} = VDD - 0.4V	50	-	-	μ A
I _{OL}	Logic Low Output Current Drain	V _{out} = 0.4V	-	-	-50	μ A
I _{OZ}	Logic Output Tri-state Current Drain Source	-	-1	-	1	μ A
I _{ILIH}	Logic Input Current	-	-1	-	1	μ A

Note : (1) VCIX2 efficiency = VCIX2 / (2 x VCI) x 100%

(2) VGH efficiency = VGH / (VDC x n) x 100% (where n = booster factor)

(3) VCOML < 0V, VCOMH < VCIX2J

5.5 Optical specifications

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	
Viewing Angle range	Horizontal	CR > 10	40	45	-	Deg.	Normal Pol Note 1	
			40	45	-	Deg.		
	Vertical		15	20	-	Deg.		
			30	40	-	Deg.		
Luminance Contrast ratio	CR	$\Theta = 0^\circ$	350	500			Note 2	
Transmittance	T(%)	$\Theta = 0^\circ$	6.2	6.5	-	%	Base on C light Note 3	
White Chromaticity		$\Theta = 0^\circ$	0.278	0.298	0.318		Note 4 CF Glass	
			0.311	0.331	0.351			
Reproduction of color	Red	$\Theta = 0^\circ$	0.587	0.607	0.627			
			0.310	0.330	0.350			
	Green		0.258	0.278	0.298			
			0.526	0.546	0.566			
	Blue		0.121	0.141	0.161			
			0.138	0.158	0.178			
Threshold Voltage		Vsat		2.3		V	Figure 2	
				1.27		V		
Response Time (Rising + Falling)	T_{RT}	Ta = 25°C $\Theta = 0^\circ$	-	20		ms	Note 5	

Notes : 1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see Figure 3 shown in Appendix).

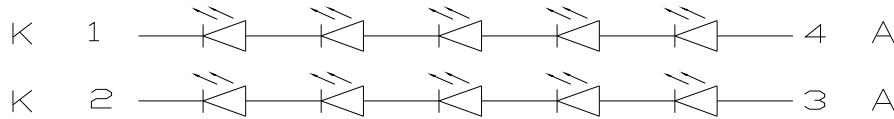
2. Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state.
(see Figure 3) Luminance Contrast Ratio (CR) is defined mathematically.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. Transmittance is the Value with Polarizer
4. The color chromaticity coordinates specified in Table 4 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.
Measurement condition is C- light Source & Halogen Lampe
5. The electro-optical response time measurements shall be made as Figure 4 by switching the "data" input signal ON and OFF. The times needed for the transmittance to change from 10% to 90% is Tr, and 90% to 10% is Td.

5.6 LED back light specification (10 White Chips)

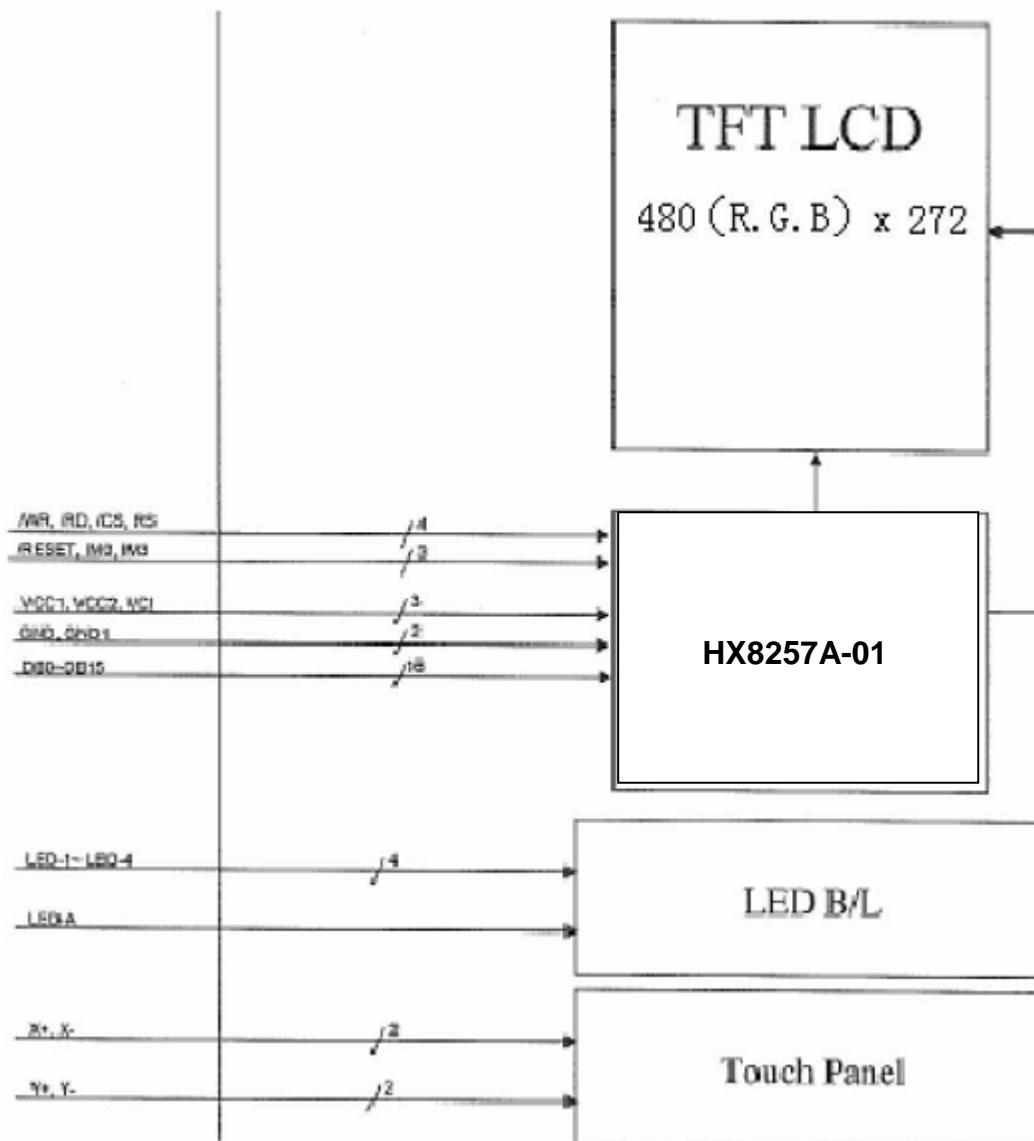
Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	Vf	If=40mA	15	16	17	V
Uniformity (with L/G)	ΔB_p	If=40mA	80	-	-	%
Luminance for LCD	L_v	If=40mA	5200	-	-	cd/m ²

LED CIRCUIT**5.7 Interface Pin Connections**

PIN NO.	Symbol	Description
1	LED-K	LED backlight(Cathode)
2	LED-A	LED backlight(anode)
3	GND	Ground
4	VCC	Power supply (Digital +3.0V)
5-12	R0-R7	Red Data
13-20	G0-G7	Green Data
21-28	B0-B7	Blue Data
29	GND	Ground
30	CLK	Clock signal
31	DISP	Display on/off
32	HSYNC	Horizontal sync input in RGB mode (short to GND if not used)
33	VSYNC	Vertical sync input in RGB mode (short to GND if not used)
34	DEN	Data Enable
35	NC	NC
36	GND	Ground
37	NC	NC
38	NC	NC
39	NC	NC
40	NC	NC

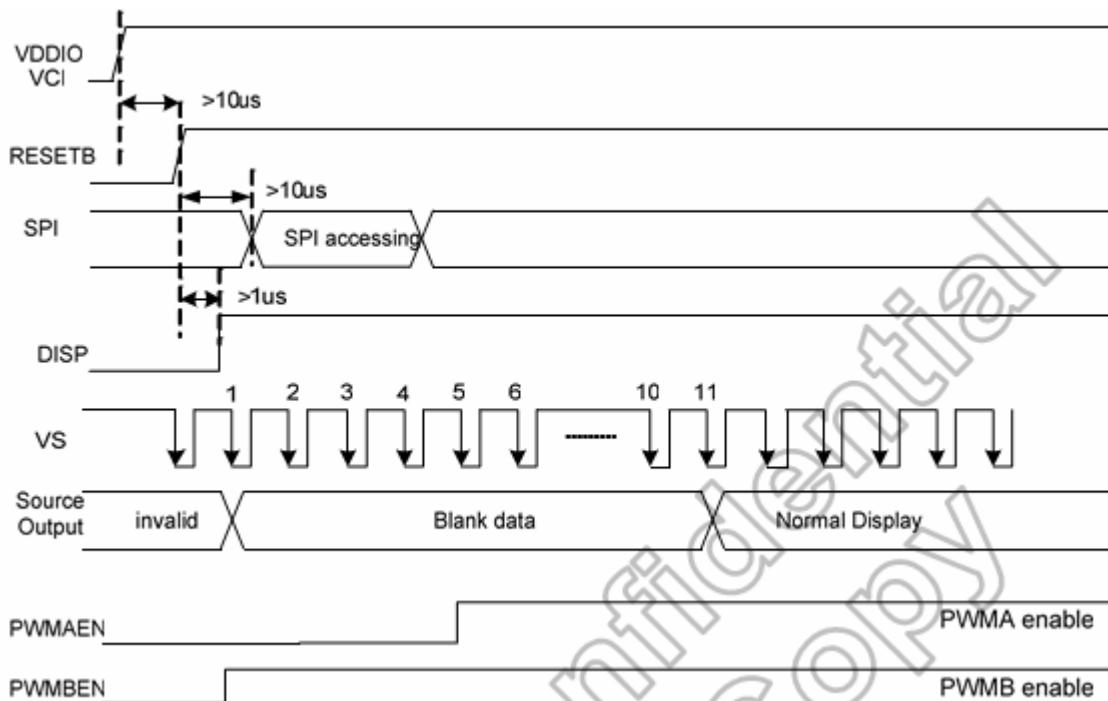
6 Signal timing diagram and Circuit block diagram

6.1 Circuit block diagram

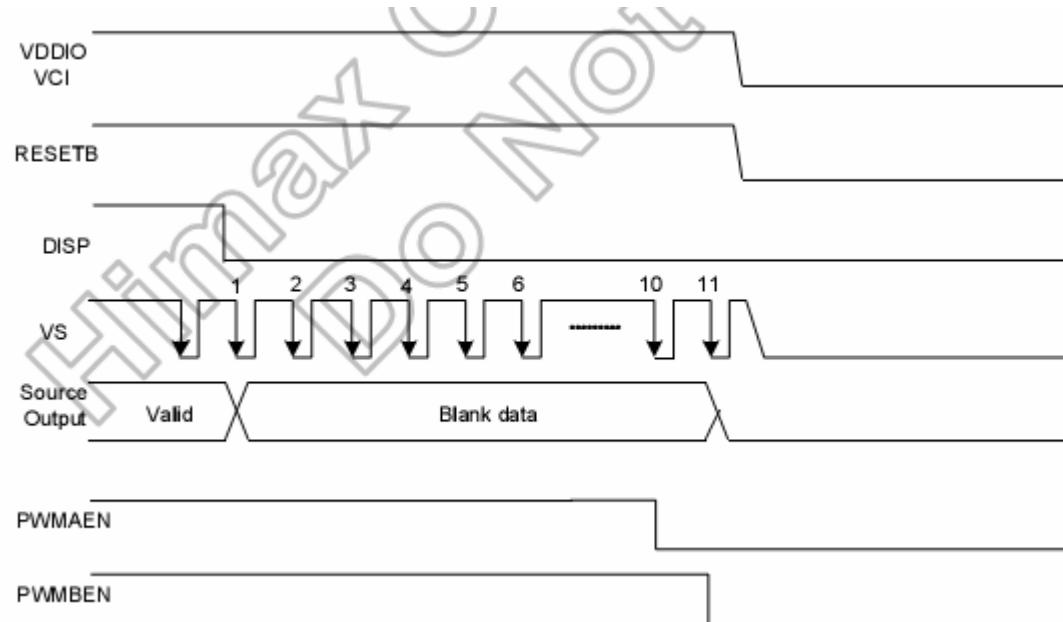


6.2 Signal Timing Diagram

6.2.1 Power ON Sequence



6.2.2 Power OFF Sequence



6.2.3 Timing Diagram of interface Signal

(480RGBx272, $T_A=25^\circ\text{C}$, $\text{VDDIO}=1.8\text{V}$ to 3.6V , $\text{DVSS}=0\text{V}$)

Parameter	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Clock cycle	$f_{\text{CLK}}^{(1)}$	-	9	15	MHz
Hsync cycle	1/th	-	17.14	-	KHz
Vsync cycle	1/tv	-	59.94	-	Hz
Horizontal Signal					
Horizontal cycle	th	525	525	605	CLK
Horizontal display period	thd	480	480	480	CLK
Horizontal front porch	thf	2	2	82	CLK
Horizontal pulse width	thp ⁽²⁾	2	41	41	CLK
Horizontal back porch	thb ⁽²⁾	2	2	41	CLK
Vertical Signal					
Vertical cycle	tv	285	286	511	$\text{H}^{(1)}$
Vertical display period	tvd	272	272	272	$\text{H}^{(1)}$
Vertical front porch	tvf	1	2	227	$\text{H}^{(1)}$
Vertical pulse width	tvp ⁽²⁾	1	10	11	$\text{H}^{(1)}$
Vertical back porch	tvb ⁽²⁾	1	2	11	$\text{H}^{(1)}$

Note: (1) Unit: $\text{CLK}=1/f_{\text{CLK}}$, $\text{H}=th$,

(2)It is necessary to keep $tvp+tvb=12$ and $thp+thb=43$ in sync mode. DE mode is unnecessary to keep it.

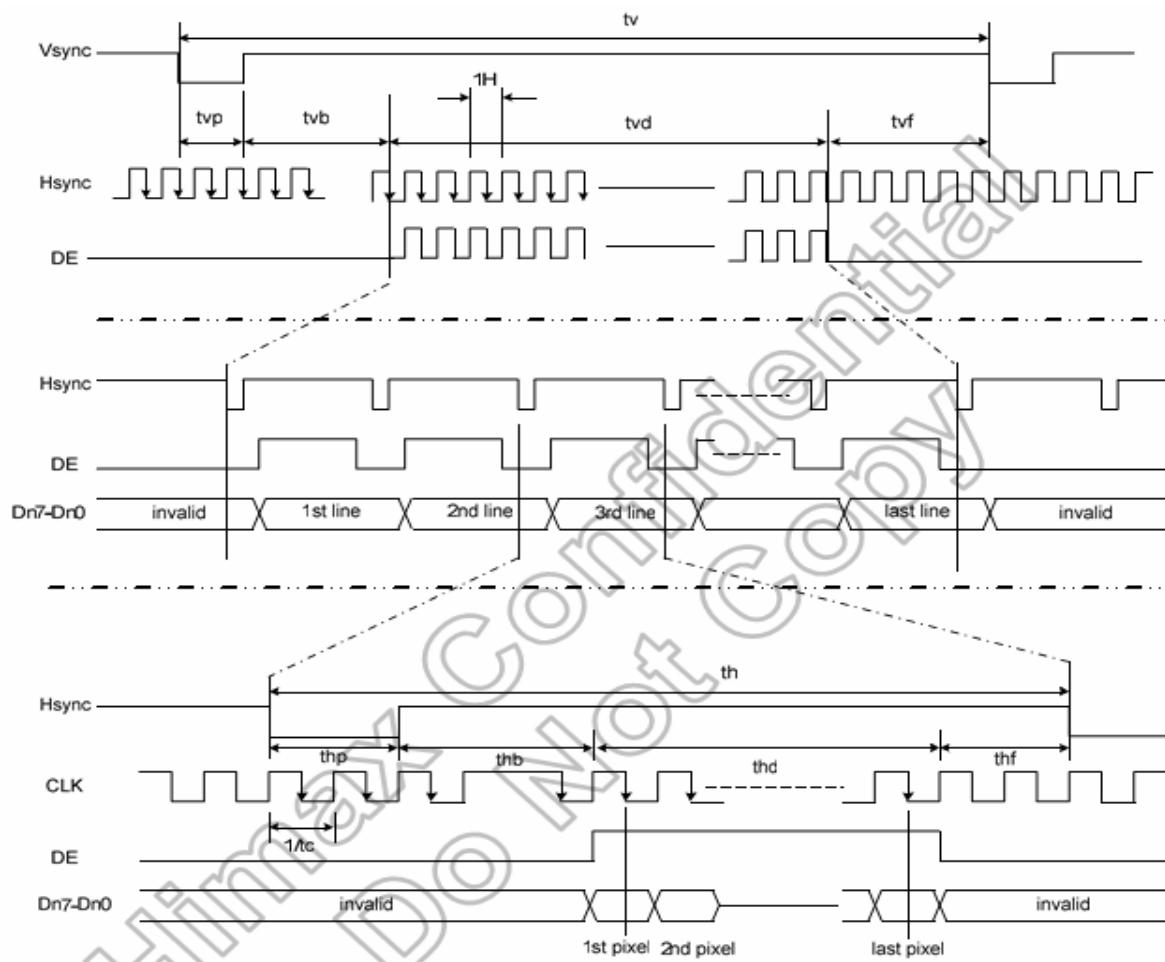


Figure 11.1 Parallel RGB Input Timing

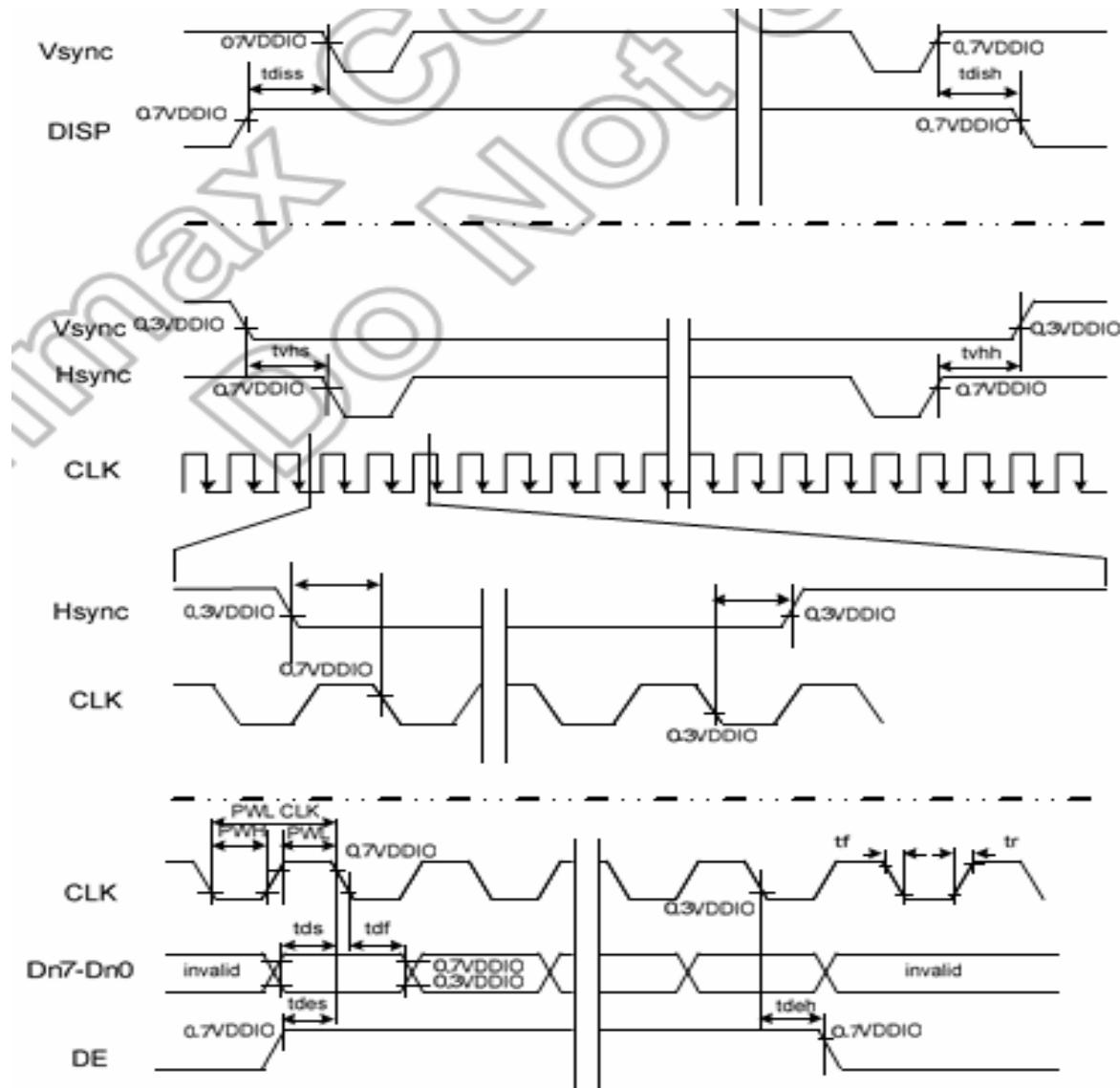
6.2.4 Input setup Timing requirement

($T_A=25^\circ\text{C}$, $VDDIO=1.8\text{V}$ to 3.6V , $DVSS=0\text{V}$, $tr^{(1)}=tf^{(1)}=2\text{ns}$)

Parameter	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
DISP setup time	t_{diss}	10	-	-	ns
DISP hold time	t_{dih}	10	-	-	ns
Clock period	$PW_{CLK}^{(2)}$	66.7	-	-	ns
Clock pulse high period	$PWH^{(2)}$	26.7	-	-	ns
Clock pulse low period	$PWL^{(2)}$	26.7	-	-	ns
Hsync setup time	t_{hs}	10	-	-	ns
Hsync hold time	t_{hh}	10	-	-	ns
Data setup time	t_{ds}	10	-	-	ns
Data hold time	t_{dh}	10	-	-	ns
DE setup time	t_{des}	10	-	-	ns
DE hold time	t_{deh}	10	-	-	ns
Vsync setup time	t_{vhs}	10	-	-	ns
Vsync hold time	t_{vh}	10	-	-	ns

Note: (1) tr, tf is defined 10% to 90% of signal amplitude.

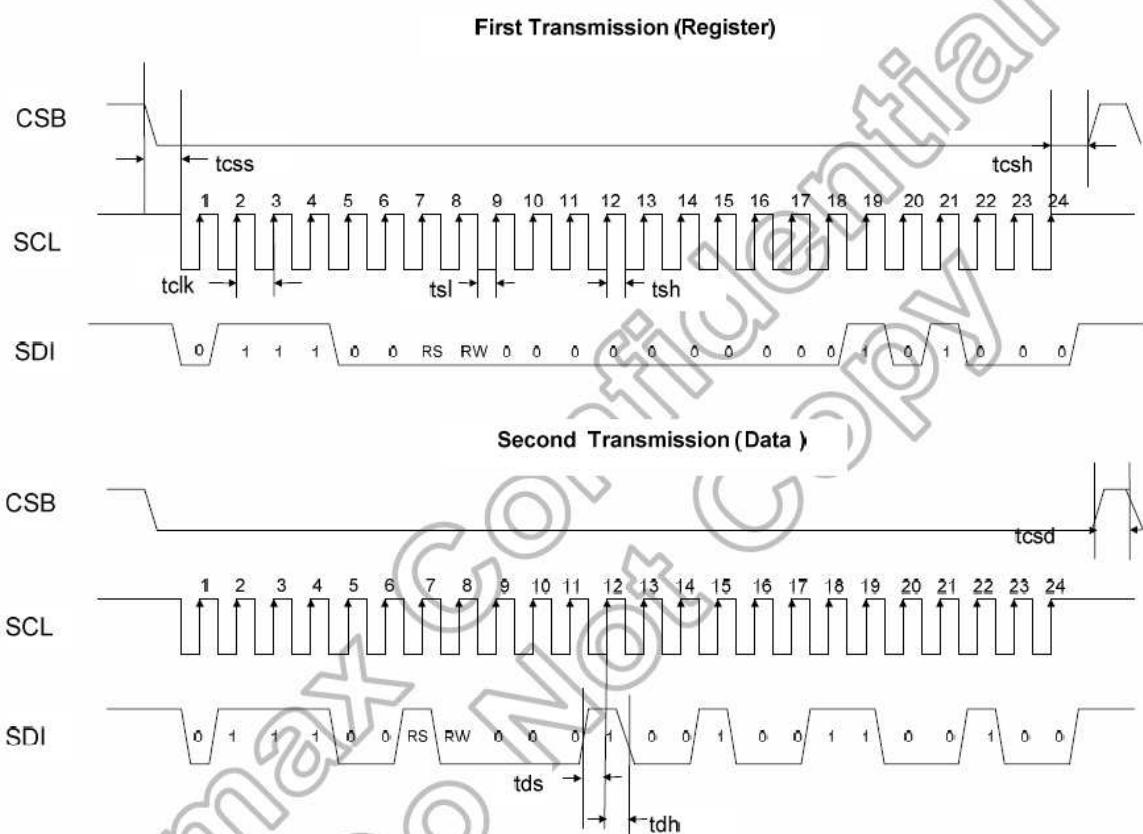
(2) For parallel interface, maximum clock frequency is 15MHz.



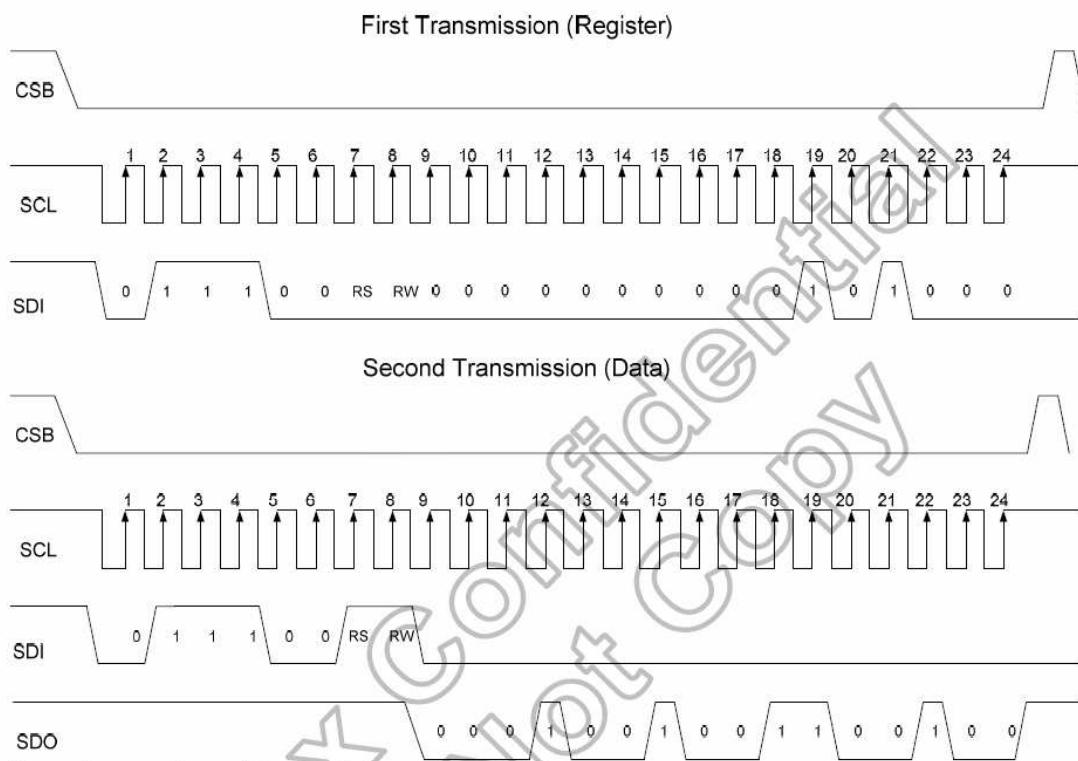
7 Initial code

8 Write/ReadSPI Timing

- Write SPI



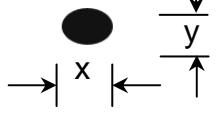
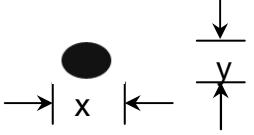
- Read SPI

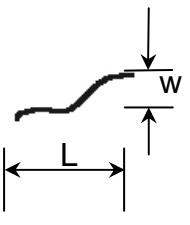
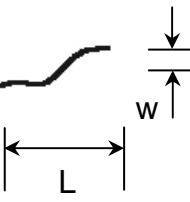


9 Reliability Test Conditions And Methods

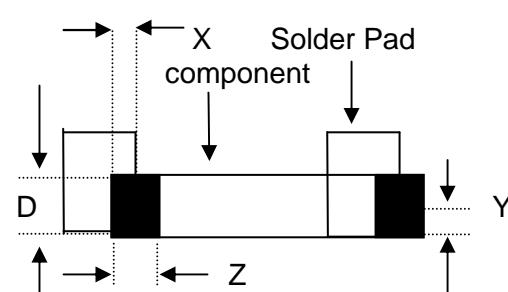
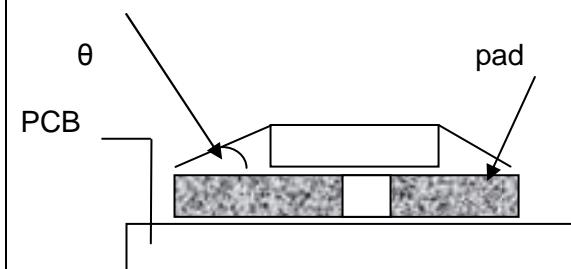
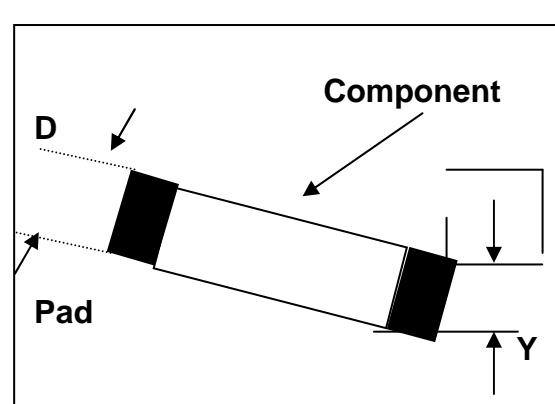
NO	Item	Condition	Method
1	High / Low Temperature Storage	80°C/-30°C 120hrs	Check and record every 48Hrs
2	High / Low Temperature Life	70°C/-20°C 120hrs (operating mode)	Check and record every 48Hrs
3	High Temperature、High Humidity Operating	60°C,90% RH, 96Hrs	Check and record every 48hrs
4	Thermal Shock	-30°C(30Min) → 25°C(5Min) → 80°C(30Min) (conversion time, : 5 sec) 20 cycles	Each 10 cycles end , check
5	Vibration	10Hz~55Hz~10Hz Amplitude: 1.5mm 2hrs for each direction(X,Y,Z)	Each direction end, Check the Appearance and Electrical Characteristics
6	Static Electricity	Gap mood: ±1KV~±8KV (10 times air discharge with positive/negative voltage voltage gap : 1kv) Touch mood: ±1KV~±4KV	Each discharge end, Check the Electrical Characteristics
7	Curve	60 Thousand times, 40 times/min 150° (according to die if exist)	Check and record every 2~4 thousand times
8	Slump	Free faller movement for each side、cording、angle (75cm High、6 sides、2 angle、2 cording)	End

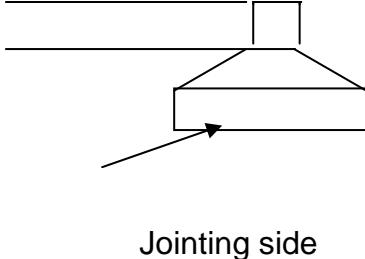
10 Inspection standard

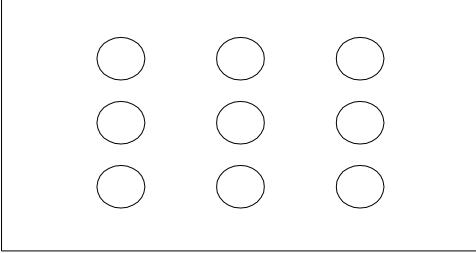
No	Item	Criterion																			
01	Outline Dimension	In accord with drawing																			
02	Position-finding Dimension Assemble Dimension	In accord with drawing																			
03	LCD black spots, white spots (Round type)	<p>Round type: non display</p> <p>3.1 Small area LCD</p>  <p>Unit : mm</p> <table border="1"> <thead> <tr> <th>Dimension</th> <th>Qualified Quantity</th> </tr> </thead> <tbody> <tr> <td>$D \leq 0.1$</td> <td>Ignore</td> </tr> <tr> <td>$0.1 < D \leq 0.15$</td> <td>2</td> </tr> <tr> <td>$D > 0.15$</td> <td>0</td> </tr> </tbody> </table> <p>3.2 Large area LCD</p>  <table border="1"> <thead> <tr> <th>Dimension</th> <th>Qualified Quantity</th> </tr> </thead> <tbody> <tr> <td>$D \leq 0.1$</td> <td>Ignore</td> </tr> <tr> <td>$0.1 < D \leq 0.15$</td> <td>2</td> </tr> <tr> <td>$0.15 < D \leq 0.20$</td> <td>1</td> </tr> <tr> <td>$D > 0.20$</td> <td>0</td> </tr> </tbody> </table> <p>C-STN : if $D > 0.1$, unqualified</p>	Dimension	Qualified Quantity	$D \leq 0.1$	Ignore	$0.1 < D \leq 0.15$	2	$D > 0.15$	0	Dimension	Qualified Quantity	$D \leq 0.1$	Ignore	$0.1 < D \leq 0.15$	2	$0.15 < D \leq 0.20$	1	$D > 0.20$	0	
Dimension	Qualified Quantity																				
$D \leq 0.1$	Ignore																				
$0.1 < D \leq 0.15$	2																				
$D > 0.15$	0																				
Dimension	Qualified Quantity																				
$D \leq 0.1$	Ignore																				
$0.1 < D \leq 0.15$	2																				
$0.15 < D \leq 0.20$	1																				
$D > 0.20$	0																				

		Unit : mm	4.1 Small area LCD					
			Length	Width	Qualified Quantity			
04	LCD black spots, white spots (Line Style)		-	≤ 0.015	Ignore			
			≤ 1.0	$0.015 < W \leq 0.025$		2		
			≤ 2.0	$0.025 < W \leq 0.05$		1		
			≤ 1.0	$0.025 < W \leq 0.05$		1		
			-	$D > 0.05$	According to circle			
4.2 Large area LCD								
			Length	Width	Qualified Quantity			
			-	≤ 0.015	Ignore			
			≤ 2.0	$0.015 < W \leq 0.025$		2		
			≤ 1.0	$0.025 < W \leq 0.05$		1		
			-	$D > 0.05$	According to circle			
CSTN : If $W \geq 0.015$, unqualified Ignore beyond viewing area								
05	LCD Scratch , Threadlike Fiber	Same to NO.3 circle sightline and surface of LCD is vertical (2)Same to NO.3 line style						
06	POL	It is not admissible that POL is beyond the edge of glass, else, unqualified. It is essential that POL is over the 50 percent of width of frame , else ,unqualified. According to the drawing in case of special definition.						
07	IC/FPC Bonding	Scratch	Reject					

		Intensity Of Adhesion	If lower than specification, reject	
		Gold Fold Twist	Reject	
07	IC/FPC Bonding	Silicon	According to outline, no gold outside, seal can not be higher than LCD	
		FPC Gold Sever	Reject	
08	SMT	Lack of Component、Polarity Inverse	If exist, reject	
		Leak Solder、Virtual Solder	If exist, reject	
		Short Circuit In Solder Point	If exist, reject	
		Tin Ball	If exist, reject	
		Tin Acumination	If visual, reject	
		Height Solder Point	If higher 0.5mm than component. reject	
		Height of component	Either side higher 0.5mm than component, reject	

		Component Shift	 <p>$X < \frac{3}{4}Z$ $y > \frac{1}{3}D$ reject</p>
08	SMT	Few Tin	 <p>If $\theta \leq 20^\circ$ reject</p>
		Component Deflection	 <p>If $Y > \frac{1}{3}D$ reject</p>
		Component Carcass Sideways	Reject

		Component Carcass Sideways	If exist with visual inspection , reject	
		Lot Tin	A: Tin accrete the solder side completely , hollowly ,Ok B: Tin accrete the solder side completely , full circle arc , ok C: Jointing include whole solder side, height of tin>50 percent of height of component, reject	
		Few Tin	A: Tin accrete the solder side completely , hollowly ,Ok B: height of tin > 1/3 of solder side of component , ok C: height of tin \leq 1/3 of solder side of component, reject	
08	SMT	<p>Normal</p>  <p>Jointing side</p>		
09	Light	Short circuit 、 Open circuit	Forbid	
		Quality of CSTN Display	1、 Rolling strake with visual inspection, forbid 2、 Differentness of color in viewing area with visual inspection (full white、 red、 green、 blue), forbid 3 、 Display change with visual inspection , forbid	

10	Color Of CIE Coordinate	<table border="1"> <thead> <tr> <th></th><th>x</th><th>y</th></tr> </thead> <tbody> <tr> <td>white</td><td>± 0.05</td><td>± 0.05</td></tr> <tr> <td>Red</td><td>± 0.05</td><td>± 0.05</td></tr> <tr> <td>Green</td><td>± 0.05</td><td>± 0.05</td></tr> <tr> <td>Blue</td><td>± 0.05</td><td>± 0.05</td></tr> </tbody> </table> <p>According to the specification or sample customer have approved</p>		x	y	white	± 0.05	± 0.05	Red	± 0.05	± 0.05	Green	± 0.05	± 0.05	Blue	± 0.05	± 0.05	Drive LCD under normal condition, 25°C $\phi=0$ $\theta=0$ Test white, red, green blue with DMS Record
	x	y																
white	± 0.05	± 0.05																
Red	± 0.05	± 0.05																
Green	± 0.05	± 0.05																
Blue	± 0.05	± 0.05																
11	Brightness	In accord with product specification	<p>Drive condition is according to specification Measure location is in Follow Picture 3、Adjust brightness instrument to zero, burrow against the surface of LCD, press "measure", record when the display is steady. (YOKOGAWA-3298)</p> 	Measure location														
12	CR (Max)	According to specification	<p>According to product specification Measure instrument (DMS-501)</p>	Measure location														
13	Response time	According to specification	<p>According to product specification Measure instrument (DMS-501)</p>															
14	Viewing angle	According to specification	<p>According to product specification Measure instrument (DMS-501)</p>	Measure location														
15	Vibration, Ring	Compare with the sample customer supply	<p>Compare with the sample customer supply when assemble</p>															
16	Frequency Of FPC Bend	According to the use of product (main FPC of foldaway cell phone ≥ 6 thousand)	<p>Measure instrument Bend angle : 150° Fix FPC in the casement when customer supply</p>	Measure location														

11 Handling Precautions

11.1 Mounting method

The LCD panel of Daxian LCD module consists of two thin glass plates with polarizers which easily be damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

11.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

11.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

11.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

11.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's have dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified

- operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
Usage under the maximum operating temperature, 50%Rh or less is required.

11.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
[It is recommended to store them as they have been contained in the inner container at the time of delivery from us]

11.7 Safety

- It is recommendable to crush damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

12 Precaution for use

12.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

12.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to Daxian, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

13 Dimensional Outline

